SPECIFICATION FOR APPROVAL

DESCRIPTION: 7+6 Pin SLIM SATA F	Plug, SMT Type	
CUSTOMER PROD.NO/DWG.NO:		
E&T PROD.NO:	8651K-X13N-XXX	
APPROVAL SHEET NO:		
E&T DWG. NO./DOCUMENT:	8651K-X13N-XXX	
		DEW: A1

PLEASE RETURN TO US ONE COPY OF SPECIFICATION FOR APPROVAL WITH YOUR APPROVED SIGNATURES.

APPROVED SIGNATURES				



ENTERY INDUSTRIAL CO., LTD. E&T ELECTRONICS (DONG GUAN) CO., LTD. E&T ELECTRONICS (SU ZHOU) CO., LTD.

Title: 7+6 Pin SLIM SATA Plug SMT Type

Max Lee Title: 7+6 Pin Slim SATA Plug, SMT Type			
A1 Rev	07,26'2010 Description	This Document Contains Information That Is Proprietary To E&T And Should Not Be Used Without Written Permission	
Document No		Prepared By: Max Lee	Date: 11,24'2009
8651K-X13N-XXX		Checked By: Approved By:	Date: 74

GROUP AND TEST SEQUENCE

Test of Examination			Test Group					
	rest of Examination		В	С	D	Е	F	G
1	Examination of Product	1,5	1,9	1,8	1,8	1,7	1,3	1,3
2	Low-Level Contact Resistance(LLCR)	2,4	3,7	2,4,6		4,6		
3	Insulation Resistance				2,6			
4	Dielectric Strength				3,7			
5	Current Rating			7				
6	Insertion Force		2					
7	Removal Force		8					
8	Durability	3	4(a)			2(a)		
9	Physical Shock		6					
10	Vibration		5					
11	Humidity				5			
12	Temperature Life			3				
13	Reseating(Manually Unplug/Plug Three Times)			5		5		
14	Mixed Flowing Gas					3		
15	Thermal Shock				4			
16	Solder Ability						2	
17	Soldering Heat Withstanding							2

NOTE

(a) Preconditioning, 20 Cycles For The 50-Durability Cycle Requirement, 50 Cycles For The 500-Durability Cycle Requirement. The Insertion And Removal Cycle Is At The Maximum Rate Of 200 Cycles Per Hour.

PRODUCT SPECIFICATION

1. SCOPE:

This product specification contains the test method, the general performance and requirement for interconnection system connectors. The specification covers 8651 series connectors manufactured by ENTERY INDUSTRIAL CO.. LTD.

2. PRODUCT NAME AND PART NUMBER:

Product Name	E&T Part Number		
7+6 Pin Slim SATA Plug, SMT Type	8651K-X13N-XXX		

3. RATINGS:

Item	Standard	
Rated Voltage (MAX.)	30 V	DC
Rated Current (MAX.)	1.5A	
Operating Temperature Range	-40°C ~ +80°C	

^{*}Including terminal temperature rise

4.PERFORMANCE:

4- 1 Electrical Performance

	Item	Test Condition	Requirement
4-1-1	Insulation Resistance	EIA 364-21 After 500 VDC for 1 minute, measure the insulation resistance between the adjacent contacts of mated and unmated connector assemblies.	1000 MΩ (min)
4-1-2	Dielectric Strength	EIA 364-20 Method B Test between adjacent contacts of mated and unmated connector assemblies. Test Voltage: 500V AC. Test Time: 60 sec.	No Breakdown
4-1-3	Low-Level Contact Resistance(LLCR)	EIA 364-23 Subject mated contacts assembled in housing to 20 mV maximum open circuit at 100 mA maximum	30 mΩ MAX. Resistance increase 15 mΩ maximum after stress
4-1-4	Contact Current Rating (Power Segment)	 Mount the connector to a test PCB Wire power pins P1, P2, and P3 in parallel for power Wire ground pins P4, P5, and P6 in parallel for return Supply 4.5 A total DC current to the power pins in parallel, returning from the parallel ground pins Record temperature rise when thermal equilibrium is reached 	1.5 A per pin minimum. The temperature rise above ambient shall not exceed 30°C at any point in the connector when contact positions are powered. The ambient condition is still air at 25°C

4-2 Mechanical Performance

	Item	Test Condition	Requirement
4-2-1	Cappage Cappage	EIA 364-13 Measure the force necessary to mate the connector assemblies at a max. rate of 12.5 mm per minute.	45N (MAX)
4-2-2	Cabled Signal Connector	EIA 364-13 Measure the force necessary to unmate the connector assemblies at a max. rate of 12.5 mm per minute.	
4-2-3	Connector	EIA 364-13 Measure the force necessary to mate the connector assemblies at a max. rate of 12.5 mm per minute.	45N (MAX)
Removal Force Cabled Power		EIA 364-13 Measure the force necessary to unmate the	10N (Min). For Cycles 1 Through 5
	COLLICCIO	connector assemblies at a max. rate of 12.5 mm per minute.	8N (Min). Through 50 Cycles
4-2-5	Backplane Connector	EIA 364-13 Measure the force necessary to mate the connector assemblies at a max. rate of 12.5 mm per minute.	20N (MAX)
4-2-6	Backplane Connector	EIA 364-13 Measure the force necessary to unmate the connector assemblies at a max. rate of 12.5 mm per minute.	2.5N (Min). After 500 Cycles
4-2-7		EIA 364-13 Apply a static 25N unmating test load	No damage and no disconnector through 50 mating cycles

4-3 Environmental Performance and Others

	Item	Test Condition	Requirement
4-3-1	Durability	EIA 364-09 50 cycles for internal cabled application; 500 cycles for backplane/blindmate application. Test done at a maximum rate of 200 cycles per hour.	No physical damage. Meet requirements of additional tests as specified in the test sequence
4-3-2	Physical Shock	EIA 364-27 Condition H Subject mated connectors to 30 g's half-sine shock pulses of 11 msec duration. Three shocks in each direction applied along three mutually perpendicular planes for a total of 18 shocks. See NOTE 2.	No discontinuities of 1 μ s or longer duration. No physical damage.
4-3-4	Random Vibration	EIA 364-28 Condition V Test letter A Subject mated connectors to 5.35 g's RMS. 30 minutes in each of three mutually perpendicular planes. See NOTE 2.	No discontinuities of 1 μ s longer duration.

	Item	Test Condition	Requirement
4-3-5	Humidity	EIA 364-31 Method II Test Condition A. Subject mated connectors to 96 hours at 40℃ with 90% to 95% RH.	See NOTE 1
4-3-6	Temperature Cycling	EIA 364-17 Test Condition III Method A. Subject mated connectors to temperature life at +85°C for 500 hours.	See NOTE 1
4-3-9	Thermal Shock	EIA 364-17 Test Condition III Method A. Subject mated connectors to 10 cycles between −55°C and +85°C.	See NOTE 1
4-3-10	Mixed Flowing Gas	Half of the samples are exposed unmated for seven days, then mated for remaining seven days. Other half of the samples are mated during entire testing.	See NOTE 1
4-3-11	Solderadility	EIA364-52 Steam age 8 hour at $90^{\circ}\text{C} \sim 96^{\circ}\text{C}$ Solder time to be 5±1 seconds at 245 $^{\circ}\text{C}$, using unactivated flux.	More than 95% of the immersion shall be covered with solder.
7-8	Soldering heat withstanding	Wave soldering: It shall be tested in accordance with EIA364-56 Procedure 3.Test condition C. Soldering temperature: 255±5°C Immersion Duration: 10±2 sec Reflow soldering (Infrared): Refer soldering method The conditions specified on paragraph 6 Shell be repeated twice.	Inspect dimension during the test, no physical damage or derormed.

NOTE:

- Shall meet EIA 364-18 Visual Examination requirements, show no physical damage.
 Shock and vibration test fixture is to be determined by each user with connector vendors.

INFRARED REFLOW CONDITION

- 1) Ascending time to preheating temperature 170°C shall be 40 seconds minimum.
- 2) Preheating shall be fixed at 160...180°C for 60...90 seconds.
- 3) Heating shall be fixed at 220°C for 50...60 seconds.
- 4) At 260±5°C peak shall be 10 seconds maximum.

